

# ST13009

### High voltage fast-switching NPN power transistor

### Features

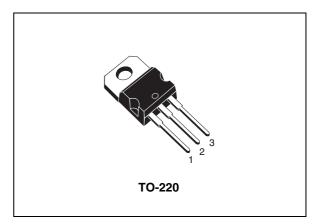
- Low spread of dynamic parameters
- High voltage capability
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

### **Applications**

Switch mode power supplies

### Description

The device is manufactured using high voltage multi-epitaxial planar technology for high switching speeds and medium voltage capability. It uses a Hollow emitter structure to enhance switching speeds.



#### Figure 1. Internal schematic diagram

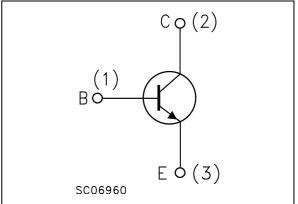


Table 1	Device	summary
	Device	Summary

Order code	Marking <sup>(1)</sup>	Package	Packaging
ST13009	13009 L 13009 H	TO-220	Tube

1. Product is pre-selected in DC current gain (group L and group H). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

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# 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>CEV</sub>	Collector-emitter voltage (V <sub>BE</sub> = -1.5 V)	700	V
V <sub>CEO</sub>	Collector-emitter voltage (I <sub>B</sub> = 0)	400	V
V <sub>EBO</sub>	Emitter-base voltage (I <sub>C</sub> = 0)	12	V
Ι <sub>C</sub>	Collector current	12	Α
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5ms)	24	Α
I <sub>B</sub>	Base current	6	Α
I <sub>BM</sub>	Base peak current (t <sub>P</sub> < 5ms)	12	Α
P <sub>tot</sub>	Total dissipation at $T_c = 25^{\circ}C$	100	W
T <sub>stg</sub>	T <sub>stg</sub> Storage temperature		°C
TJ	Max. operating junction temperature	150	°C

#### Table 3.Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case Max	1.25	°C/W

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## 2 Electrical characteristics

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$ 

Table 4.	Electrical characteristics					
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CEV</sub>	Collector cut-off current $(V_{BE} = -1.5 \text{ V})$	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V T <sub>C</sub> = 100°C			10 500	μΑ μΑ
I <sub>EBO</sub>	Emitter cut-off current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 10 V			10	μA
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 10 mA	400			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	$\begin{array}{cccccccccccccccccccccccccccccccccccc$			0.85 0.9 1.25 2.5	< < < <
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	$I_{\rm C} = 5 \text{ A}$ $I_{\rm B} = 1 \text{ A}$ $I_{\rm C} = 8 \text{ A}$ $I_{\rm B} = 1.6 \text{ A}$			1.2 1.6	V V
h <sub>FE</sub> <sup>(1)(2)</sup>	DC current gain	$I_{C} = 5 A$ $V_{CE} = 5 V$ Group L Group H $I_{C} = 8 A$ $V_{CE} = 5 V$	15 26		28 39 30	
t <sub>s</sub> t <sub>f</sub>	Inductive load Storage time Fall time	$I_{C} = 5 A$ $V_{CC} = 250 V$ $I_{B1} = 1 A$ $I_{B2} = -2 A$ $L = 200 \mu H$ see <i>Figure 9</i>		1.6 60	2.5 110	μs ns
t <sub>s</sub> t <sub>f</sub>	Inductive load Storage time Fall time	$I_{C} = 5 A$ $V_{CC} = 125 V$ $I_{B1} = -I_{B2} = 1.6 A$ $L = 200 \mu H$ $t_{c} = 125 °C$ see <i>Figure 9</i>		2.3 110		μs ns

Table 4. Electrical characteristics

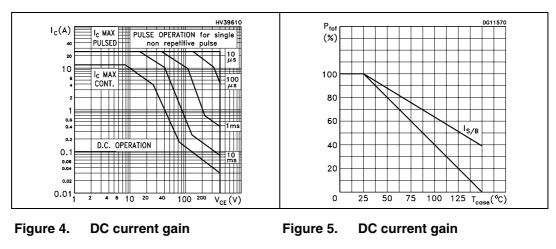
1. Pulsed duration = 300 ms, duty cycle  $\leq 2 \%$ 

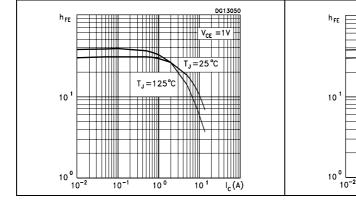
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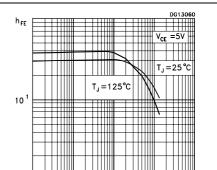
### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

### Figure 3. Derating curve







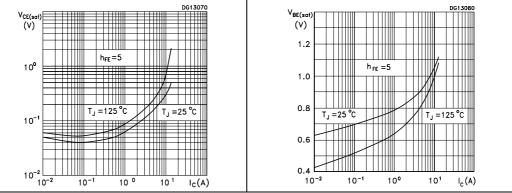
10<sup>0</sup>

10<sup>1</sup>

 $I_{c}(A)$ 

10





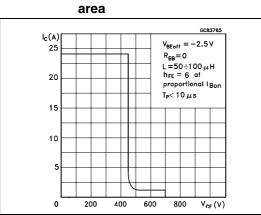


Figure 8. Reverse biased operating area



# 3 Test circuit

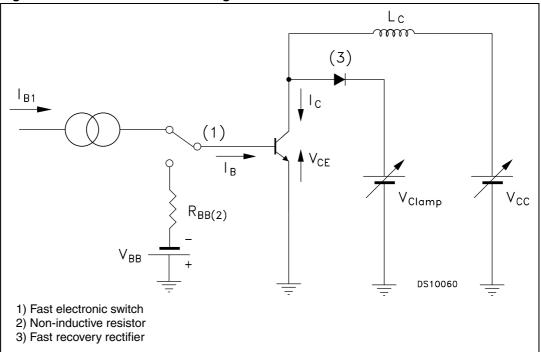


Figure 9. Inductive load switching test circuit



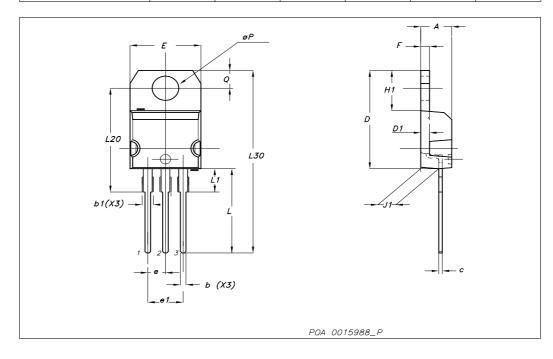
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



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Dim		mm			inch		
Dim	Min	Тур	Max	Min	Тур	Max	
Α	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.14		1.70	0.044		0.066	
С	0.49		0.70	0.019		0.027	
D	15.25		15.75	0.6		0.62	
D1		1.27			0.050		
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.051	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137		
ØP	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



#### TO-220 mechanical data



# 5 Revision history

#### Table 5.Document revision history

Date	Revision	Changes
12-Jun-2005	1	First version
23-Aug-2007	2	Added figures: 2, and 3



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